

9		8	
FINISH: NOTE 2	1 = TIN		
DIM. D:	$\frac{3.390.25}{.133.010}$		
PCB THICKNESS:	$\frac{3.18}{.125}$		
CIRCUITS	MATERIAL NO.		
04	43879-5000		
06	43879-5001		
08			
10	43879-5003		
12			
14	43879-5005		
16			
18	43879-5007		
20			
22			
24	43879-5010		

7		6	
FINISH: NOTE 2	4 = GOLD & TIN		
DIM. D:	$\frac{3.390.25}{.133.010}$		
PCB THICKNESS:	$\frac{3.18}{.125}$		
CIRCUITS	MATERIAL NO.		
04	43879-5033		
06	43879-5034		
08			
10	43879-5036		
12			
14	43879-5038		
16			
18	43879-5040		
20			
22			
24	43879-5043		

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												
QUALITY SYMBOLS 	CHG DIM 5.82 TO 6.25 EC NO: 104170 DRWN: CSLAFTER CHKD: FSMITH APPR: FSMITH REV: E1	2016/04/11 2016/05/17 2016/05/17	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION UNITS	SCALE	 MINI-FIT JR BMI/CPI HEADER ASSEMBLY W/ BOARD MOUNTING CLIPS PRODUCT CUSTOMER DRAWING					
			MM	INCH	MM/IN	2:1						
			4 PLACES	±	±	POLGAR				2003/04/06		
			3 PLACES	±	± 0.01	MARGULIS				2003/04/17		
			2 PLACES	± 0.25	± 0.014	FSMITH	2012/06/01					
			1 PLACES	± 0.35	±	DRAWING SIZE		THIRD ANGLE PROJECTION	SERIES: 43879 MATERIAL NUMBER: SEE CHART CUSTOMER: GENERAL MARKET			
			0 PLACES	±	±	B			DOCUMENT NUMBER: SD-43879-051 DOC TYPE: PSD DOC PART: 000 SHEET NUMBER: 2 OF 2			
			ANGULAR TOL ± 0.5		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS							
			RELEASE STATUS: P1 RELEASE DATE: 2016/05/17 21:36:30									